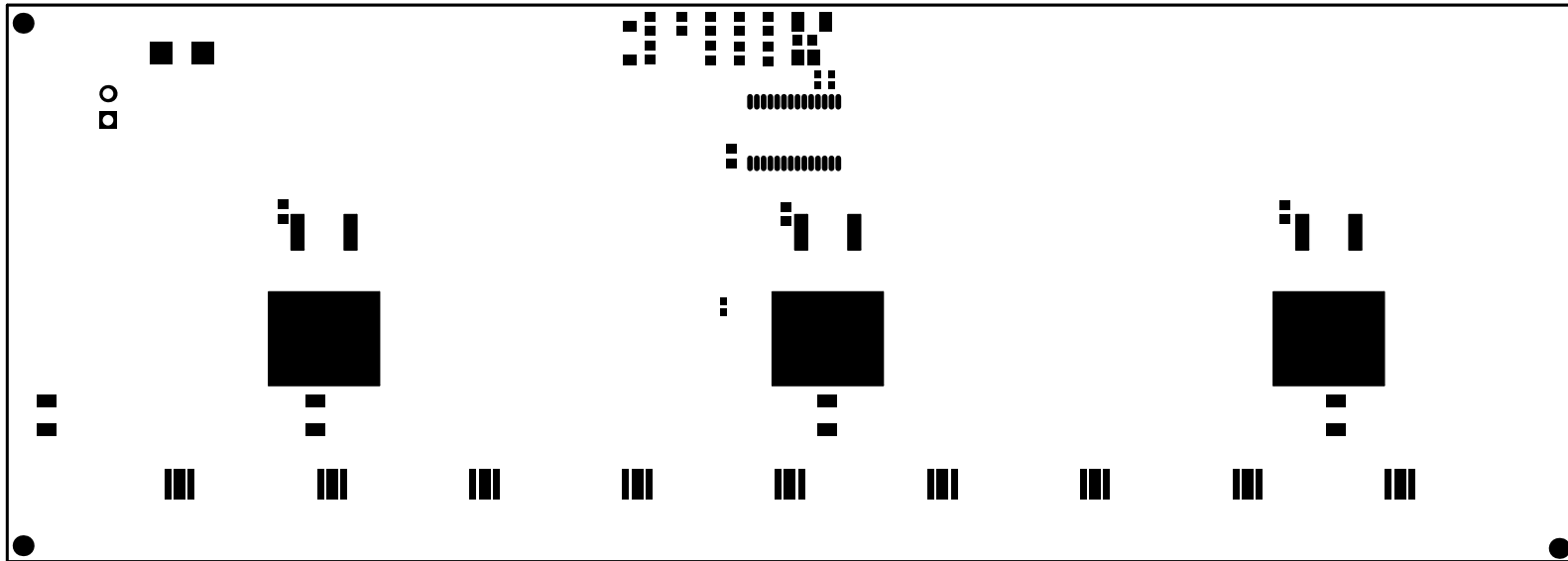
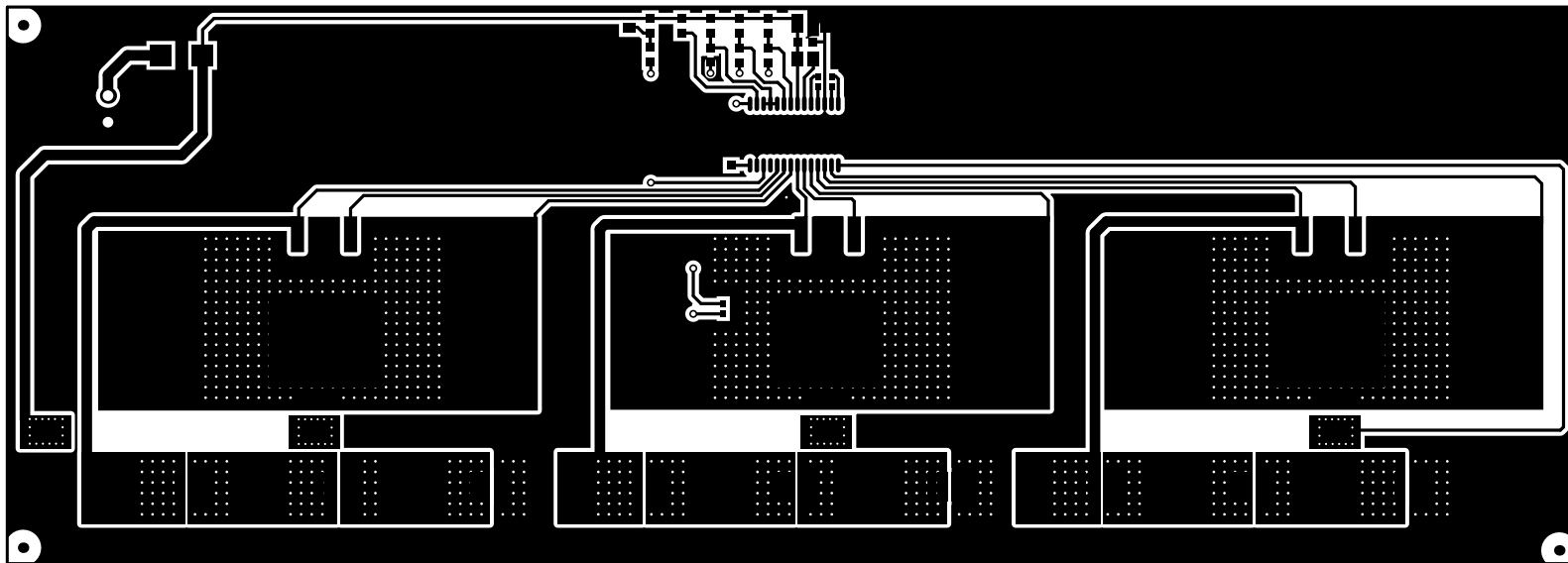


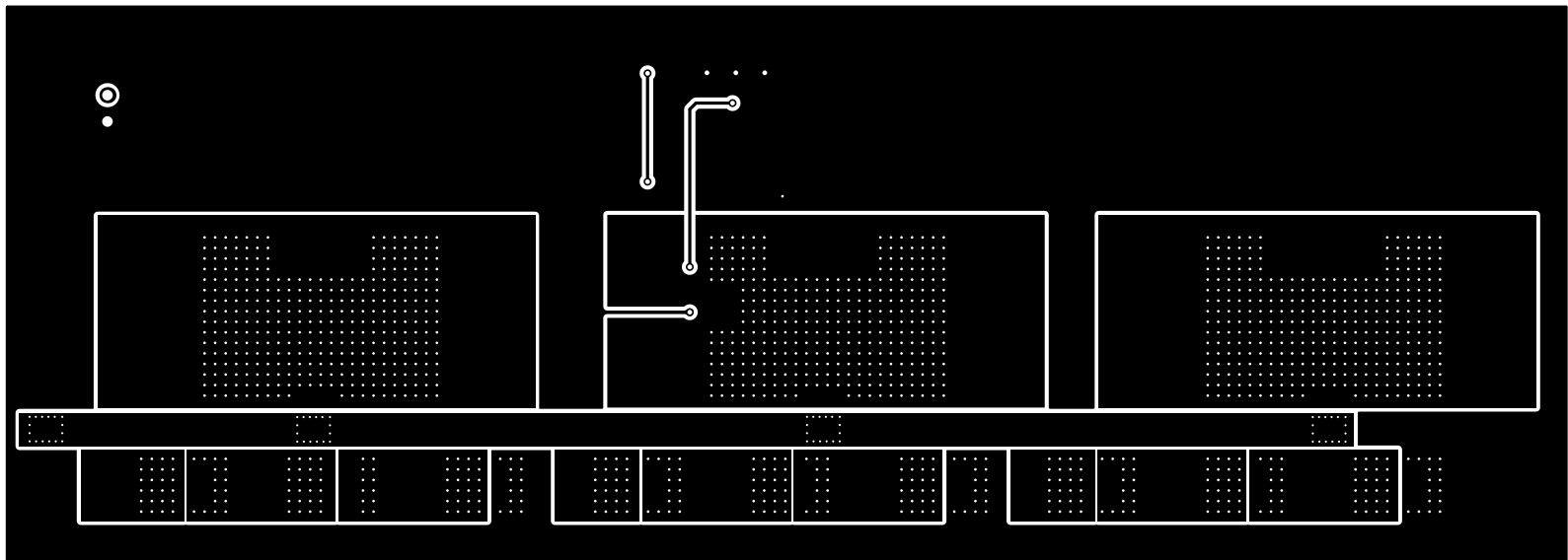
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01376		
PLOT NAME = Top Overlay	GENERATED : 4/4/2018	1:58:00 PM	TEXAS INSTRUMENTS



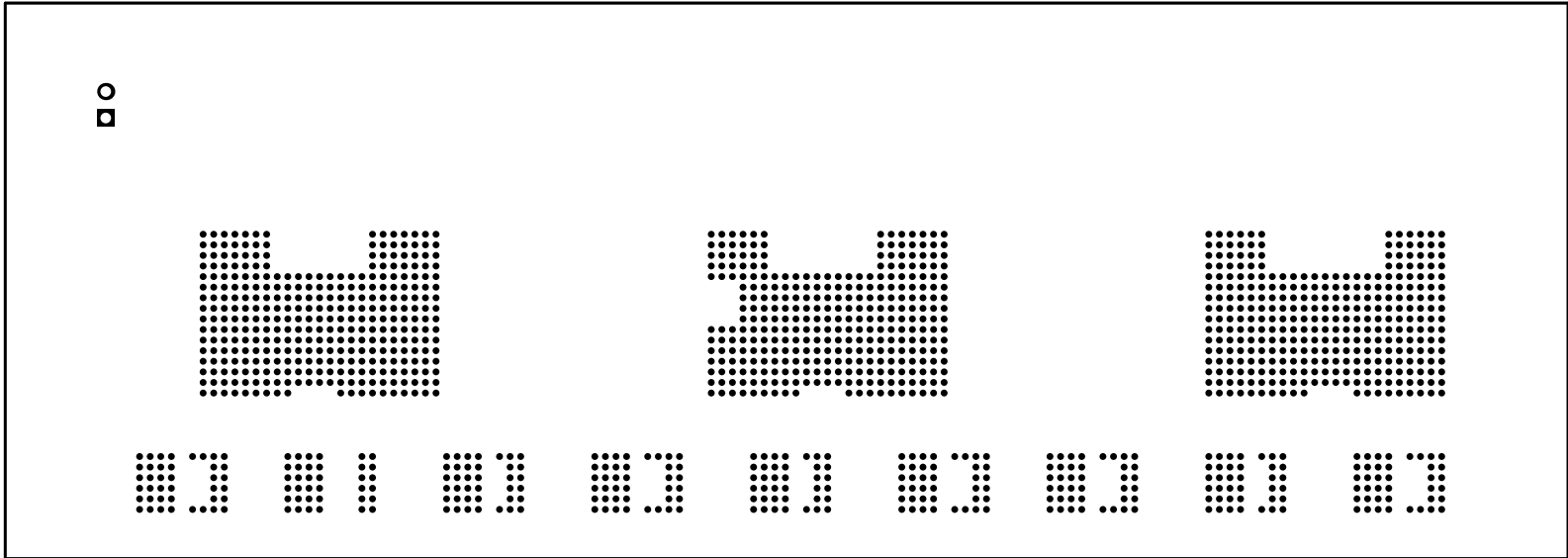
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01376		
PLOT NAME = Top Solder Mask	GENERATED : 4/4/2018	1:58:01 PM	TEXAS INSTRUMENTS



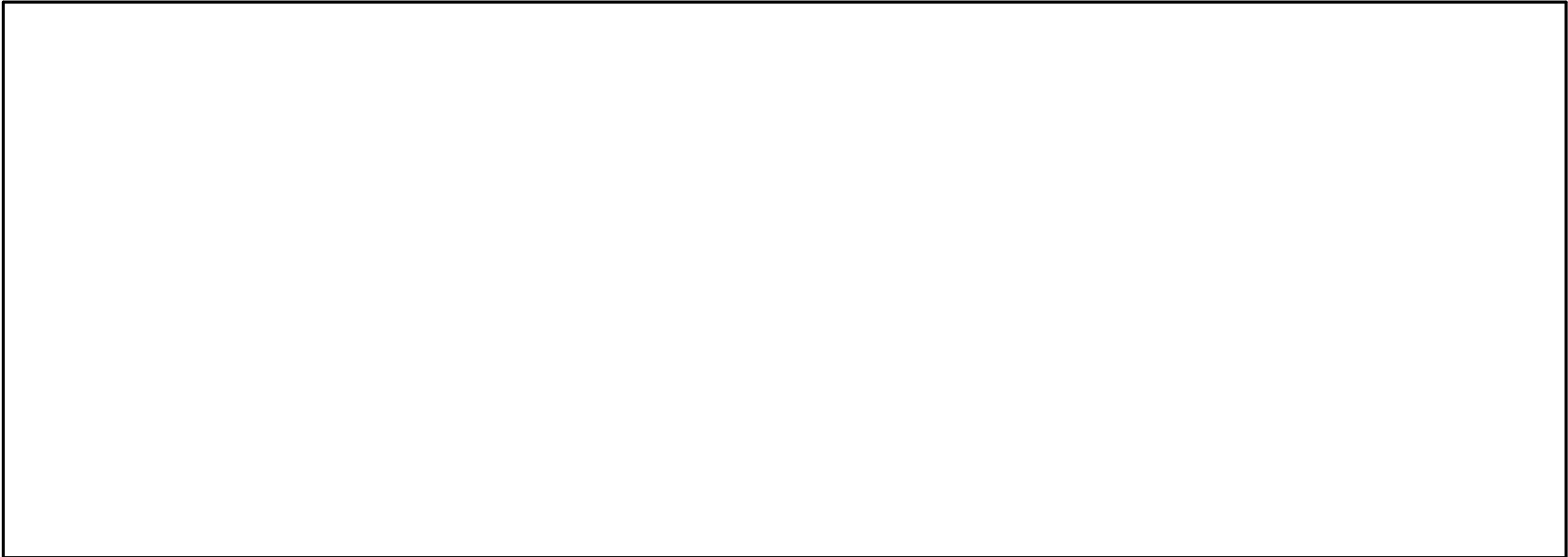
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01376		
PLOT NAME = Top Layer	GENERATED : 4/4/2018	1:58:02 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01376		
PLOT NAME = Bottom Layer	GENERATED : 4/4/2018	1:58:03 PM	TEXAS INSTRUMENTS

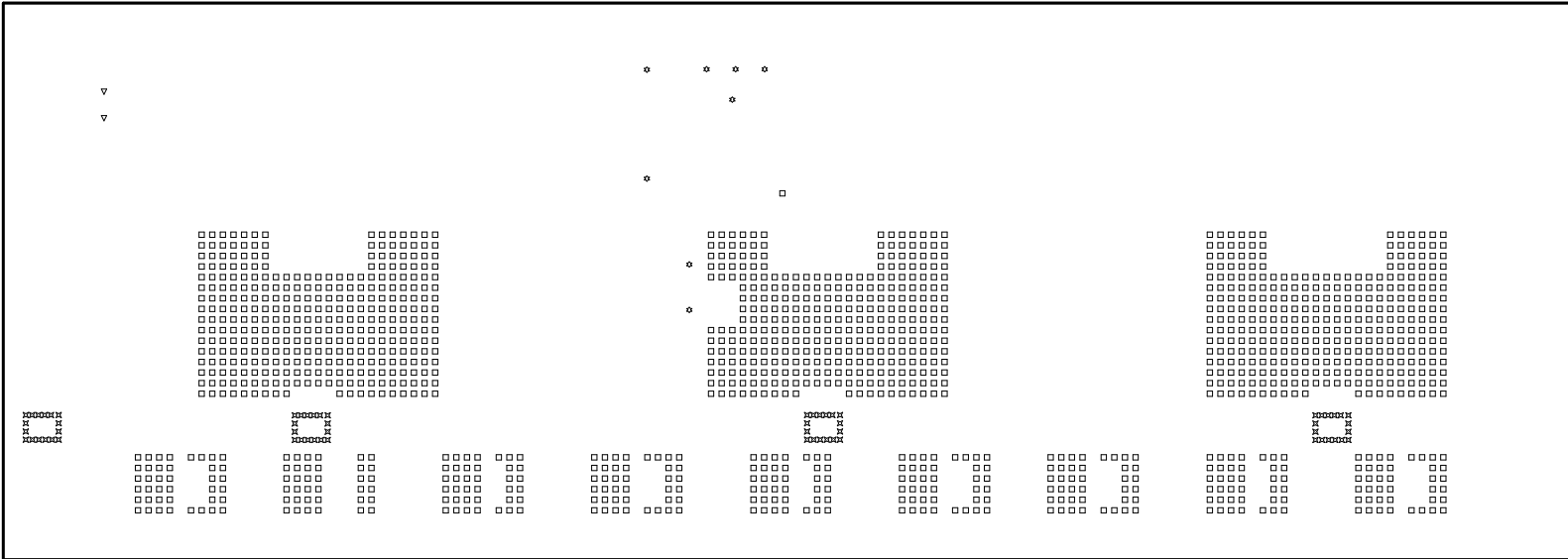


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01376		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/4/2018	1:58:05 PM	TEXAS INSTRUMENTS

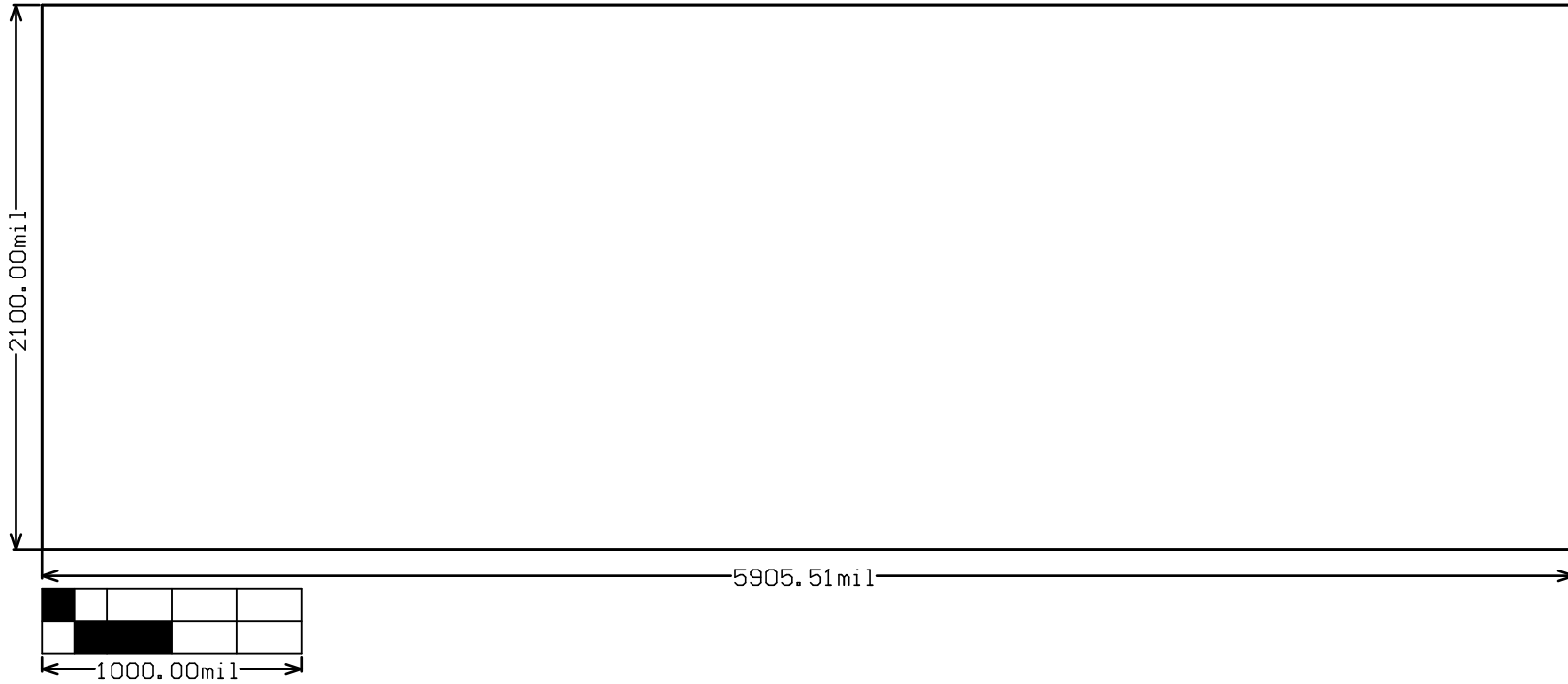


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01376		
PLOT NAME = Bottom Overlay	GENERATED : 4/4/2018	1:58:06 PM	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
✕	64	8.00mil (0.203mm)	PTH	Round
□	1311	10.00mil (0.254mm)	PTH	Round
☆	8	18.00mil (0.457mm)	PTH	Round
▽	2	40.16mil (1.020mm)	PTH	Round
	1385 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01376		
PLOT NAME = Drill Drawing	GENERATED : 4/4/2018	1:58:07 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01376	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01376		
PLOT NAME = Board Dimensions	GENERATED : 4/4/2018	1:58:10 PM	TEXAS INSTRUMENTS

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